

Global Thermal Pad for Board-Level Packaging Market 2025 by Manufacturers, Regions, Type and Application, Forecast to 2031

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Abstracts

According to our (Global Info Research) latest study, the global Thermal Pad for Board-Level Packaging market size was valued at US\$ million in 2024 and is forecast to a readjusted size of USD million by 2031 with a CAGR of %during review period.

In this report, we will assess the current U.S. tariff framework alongside international policy adaptations, analyzing their effects on competitive market structures, regional economic dynamics, and supply chain resilience.

Thermal pads for board-level packaging are specially designed thermal conductive materials that are used between PCB and packaged electronic components to help heat conduction effectively to prevent overheating of electronic components that may affect performance or shorten life. They are usually made of soft thermally conductive silicone, thermally conductive ceramic powder and other materials, and have good thermal conductivity and electrical insulation, making them suitable for dual functions of heat conduction and buffering in electronic packaging.

This report is a detailed and comprehensive analysis for global Thermal Pad for Board-Level Packaging market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Thermal Pad for Board-Level Packaging market size and forecasts, in consumption value (\$ Million), sales quantity (K Sqm), and average selling prices (US\$/Sq m), 2020-2031

Global Thermal Pad for Board-Level Packaging market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (K Sqm), and average selling prices (US\$/Sq m), 2020-2031

Global Thermal Pad for Board-Level Packaging market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (K Sqm), and average selling prices (US\$/Sq m), 2020-2031

Global Thermal Pad for Board-Level Packaging market shares of main players, shipments in revenue (\$ Million), sales quantity (K Sqm), and ASP (US\$/Sq m), 2020-2025

The Primary Objectives in This Report Are:

- To determine the size of the total market opportunity of global and key countries
- To assess the growth potential for Thermal Pad for Board-Level Packaging
- To forecast future growth in each product and end-use market
- To assess competitive factors affecting the marketplace

This report profiles key players in the global Thermal Pad for Board-Level Packaging market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Henkel Adhesives, DuPont, 3M, Rogers Corporation, Shin-Etsu Chemical, Fujipoly, Dow, Honeywell, Zhsio, Darbond, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Thermal Pad for Board-Level Packaging market is split by Type and by Application. For the period 2020-2031, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche

markets.

Market segment by Type

Silicone Thermal Pad

Ceramic Thermal Pad

Market segment by Application

PCB

LED

Others

Major players covered

Henkel Adhesives

DuPont

3M

Rogers Corporation

Shin-Etsu Chemical

Fujipoly

Dow

Honeywell

Zhsio

Darbond

Goldlink Tongda Electronics

Cybrid Technologies

Aok Technologies

Bornsun Composite Materials

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Thermal Pad for Board-Level Packaging product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Thermal Pad for Board-Level Packaging, with price, sales quantity, revenue, and global market share of Thermal Pad for Board-Level Packaging from 2020 to 2025.

Chapter 3, the Thermal Pad for Board-Level Packaging competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Thermal Pad for Board-Level Packaging breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2020 to 2031.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2020 to 2031.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2020 to 2025. and Thermal Pad for Board-Level Packaging market forecast, by regions, by Type, and by Application, with sales and revenue, from 2026 to 2031.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Thermal Pad for Board-Level Packaging.

Chapter 14 and 15, to describe Thermal Pad for Board-Level Packaging sales channel, distributors, customers, research findings and conclusion.

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